

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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|-------------|---------------------------------------------|---|------------------|---------|
| Applicants: | Jae Hak Yee et al. |) | Confirmation No. | Unknown |
| | |) | | |
| Serial No.: | Unknown |) | Art Unit: | Unknown |
| | |) | | |
| Filed: | Unknown |) | Examiner: | Unknown |
| | |) | | |
| For: | Semiconductor Package and Method |) | | |
| | of Making Leadframe Having Lead |) | | |
| | <u>Locks to Secure Leads to Encapsulant</u> | | | |

PRELIMINARY AMENDMENT

Mail Stop Non-Fee Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir/Madam:

Prior to the initial examination of the above-identified divisional patent application, please amend the application as follows: